

Rocket No. MAIKP131US

**IT601US** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

e PATENT application of:

Applicant:

Teng-Wang Huang et al.

Application No.:

10/814,570

For:

PROCESS FOR ETCHING A SUBSTRATE

Filing Date:

March 31, 2004

Examiner:

Duy-Vu Nguyen Deo

Art Unit:

1765

## **REPLY TO OFFICE ACTION DATED DECEMBER 7, 2005**

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir or Madam:

Favorable reconsideration of the above-identified application is respectfully requested in view of the following amendments and remarks.